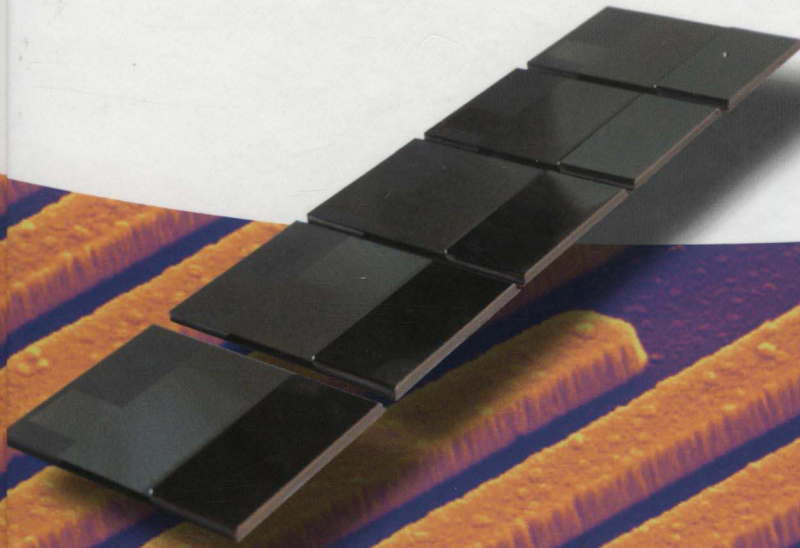


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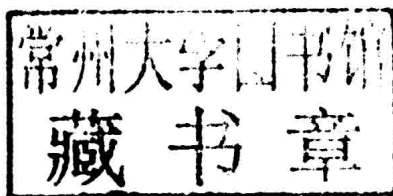
# Micro Energy Harvesting

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*Edited by Danick Briand, Eric Yeatman,  
and Shad Roundy*

## **Micro Energy Harvesting**



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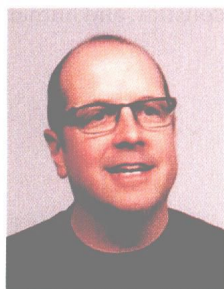
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